



# 700V Super-Junction Power MOSFET

## DESCRIPTION

### 700V super-junction Power MOSFET

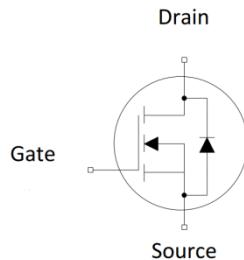
Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The SJ MOSFET is a price-performance optimized product enabling to target cost sensitive applications in Consumer and Lighting markets, designed by Wuxi Unigroup Microelectronics Company.

## FEATURES

- Very low FOM  $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

## APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



## Device Marking and Package Information

Device	Package	Marking
TPA70R260M	TO-220F	70R260M

## Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	700	V
$R_{DS(on),max}$	0.26	$\Omega$
$I_D$	15	A
$Q_{g,typ}$	27	nC
$I_{DM}$	45	A

**Absolute Maximum Ratings  $T_C = 25^\circ\text{C}$ , unless otherwise noted**

Parameter	Symbol	Value		Unit
		TO-220F		
Drain-Source Voltage ( $V_{GS} = 0\text{V}$ )	$V_{DSS}$	700		V
Continuous Drain Current $T_C = 25^\circ\text{C}$	$I_D$	15		A
$T_C = 100^\circ\text{C}$		9		
Pulsed Drain Current (note1)	$I_{DM}$	45		A
Gate-Source Voltage	$V_{GSS}$	$\pm 30$		V
Single Pulse Avalanche Energy (note2)	$E_{AS}$	290		mJ
Repetitive Avalanche Energy (note2)	$E_{AR}$	0.44		mJ
Avalanche Current	$I_{AR}$	2.4		A
MOSFET dv/dt ruggedness, $V_{DS} = 0 \dots 480\text{V}$	dv/dt	50		V/ns
Power Dissipation	$P_D$	32		W
Continuous Body Diode Current	$I_S$	12.8		A
Pulsed Diode Forward Current (note1)	$I_{SM}$	45		
Reverse diode dv/dt (note3)	dv/dt	15		V/ns
Maximum diode commutation speed (note3)	di/dt	500		A/us
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150		°C

**Thermal Resistance**

Parameter	Symbol	Value		Unit
		TO-220F		
Thermal Resistance, Junction-to-Case	$R_{thJC}$	3.9		
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	80		°C/W

**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

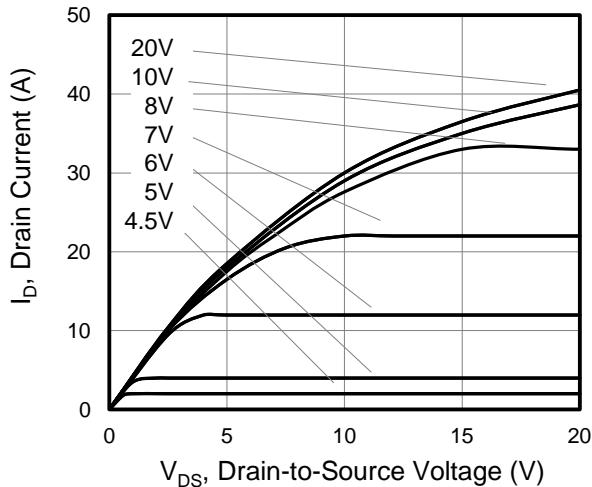
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	700	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 700\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$	--	--	1	$\mu\text{A}$
		$V_{\text{DS}} = 700\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 150^\circ\text{C}$	--	--	100	
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 30\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.5	--	4.5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 7.5\text{A}$	--	0.24	0.26	$\Omega$
Gate resistance	$R_G$	f = 1.0MHz open drain	--	12.5	--	$\Omega$
<b>Dynamic</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 100\text{V}, f = 1.0\text{MHz}$	--	1202	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	43	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	5	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 520\text{V}, I_D = 15\text{A}, V_{\text{GS}} = 10\text{V}$	--	27	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	5.5	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	10.5	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 400\text{V}, I_D = 15\text{A}, R_G = 25\Omega$	--	25	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	63	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	100	--	
Turn-off Fall Time	$t_f$		--	50	--	
<b>Drain-Source Body Diode Characteristics</b>						
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 15\text{A}, V_{\text{GS}} = 0\text{V}$	--	0.9	1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$V_R = 400\text{V}, I_F = I_S, dI_F/dt = 100\text{A}/\mu\text{s}$	--	410	--	ns
Reverse Recovery Charge	$Q_{\text{rr}}$		--	4.1	--	$\mu\text{C}$
Peak Reverse Recovery Current	$I_{\text{rrm}}$		--	20	--	A

**Notes**

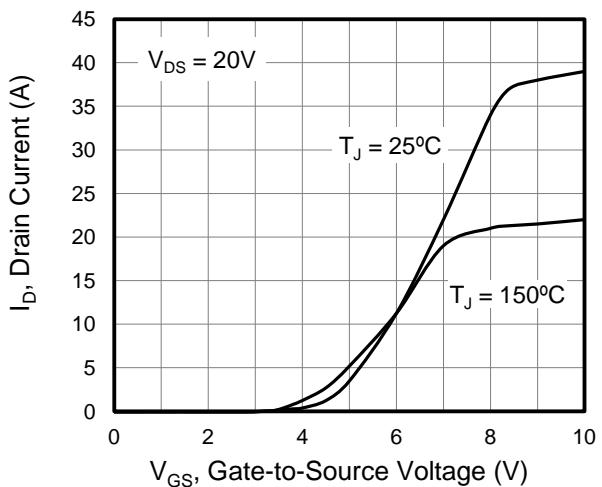
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{\text{AS}} = 2.4\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3. Identical low side and high side switch with identical  $R_G$

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

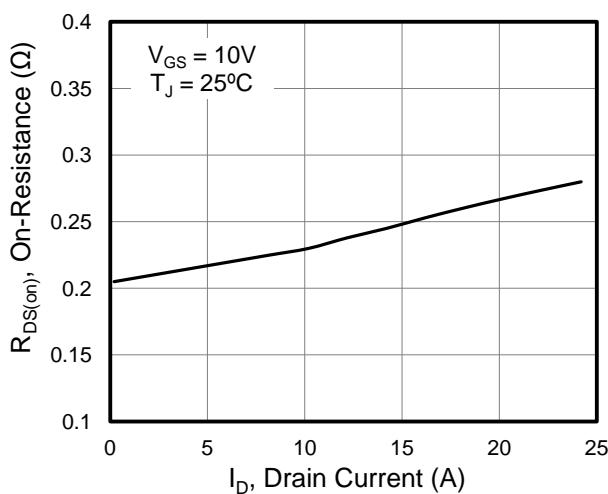
**Figure 1. Output Characteristics**



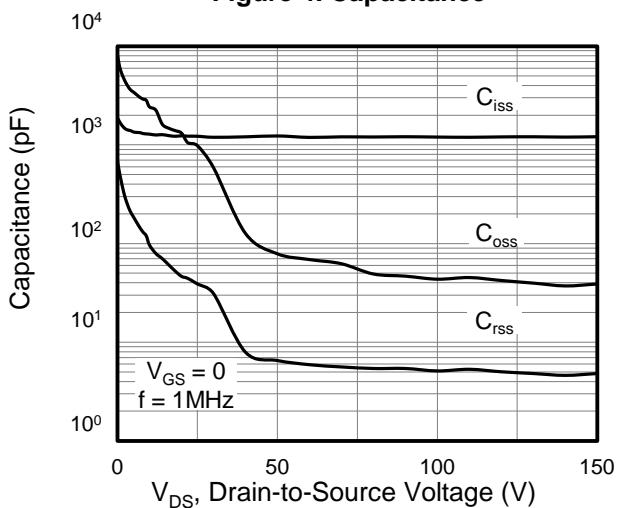
**Figure 2. Transfer Characteristics**



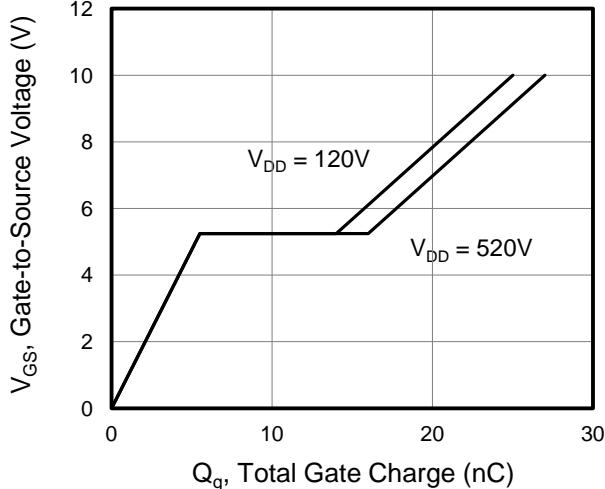
**Figure 3. On-Resistance vs. Drain Current**



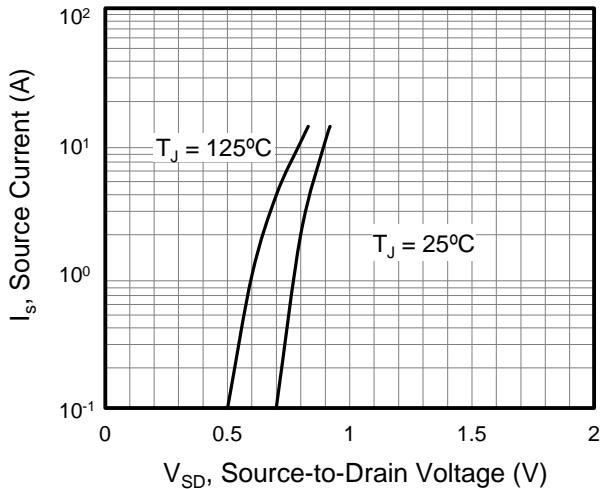
**Figure 4. Capacitance**



**Figure 5. Gate Charge**

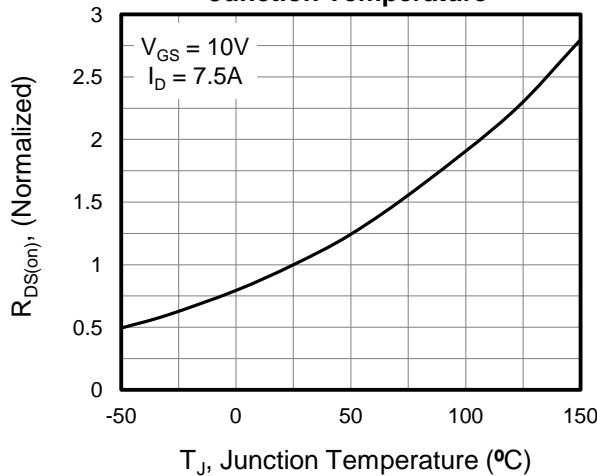


**Figure 6. Body Diode Forward Voltage**

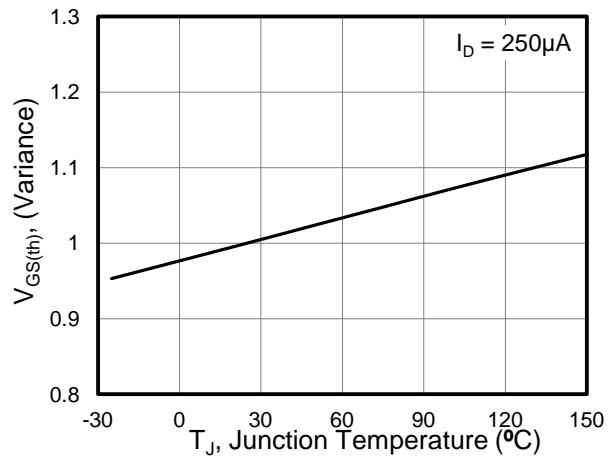


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

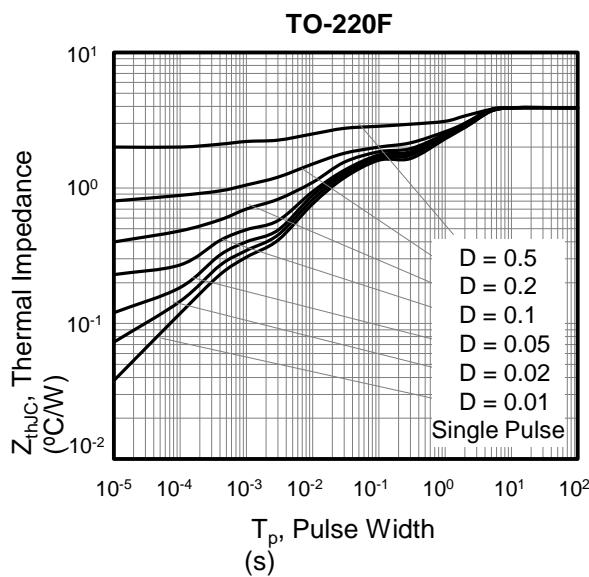
**Figure 7. On-Resistance vs. Junction Temperature**



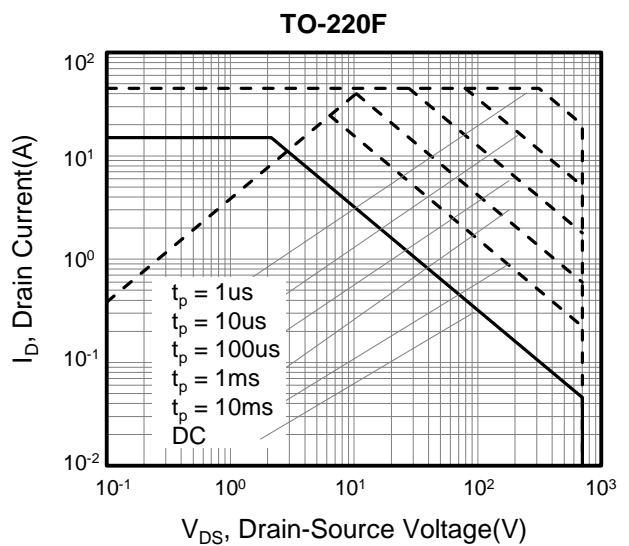
**Figure 8. Breakdown voltage vs. Junction Temperature**

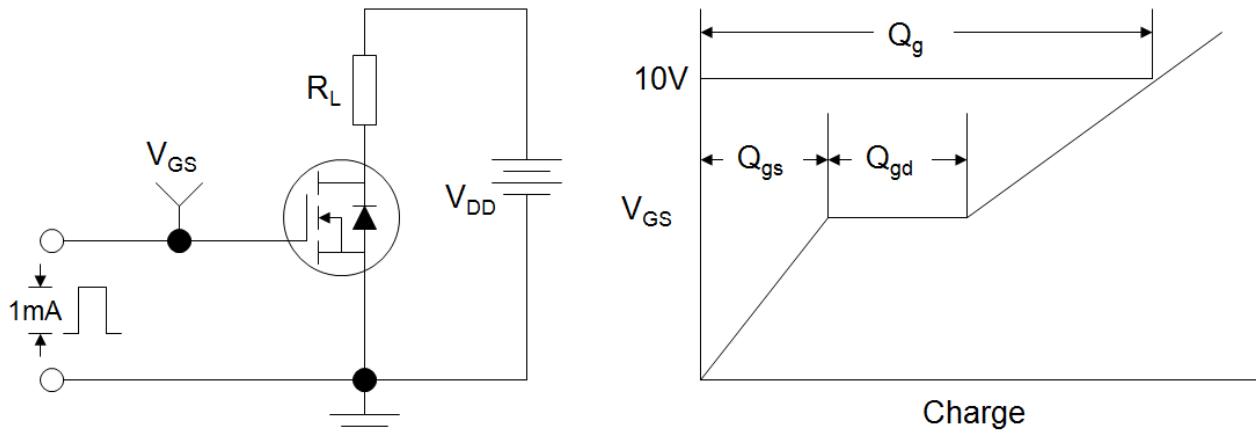
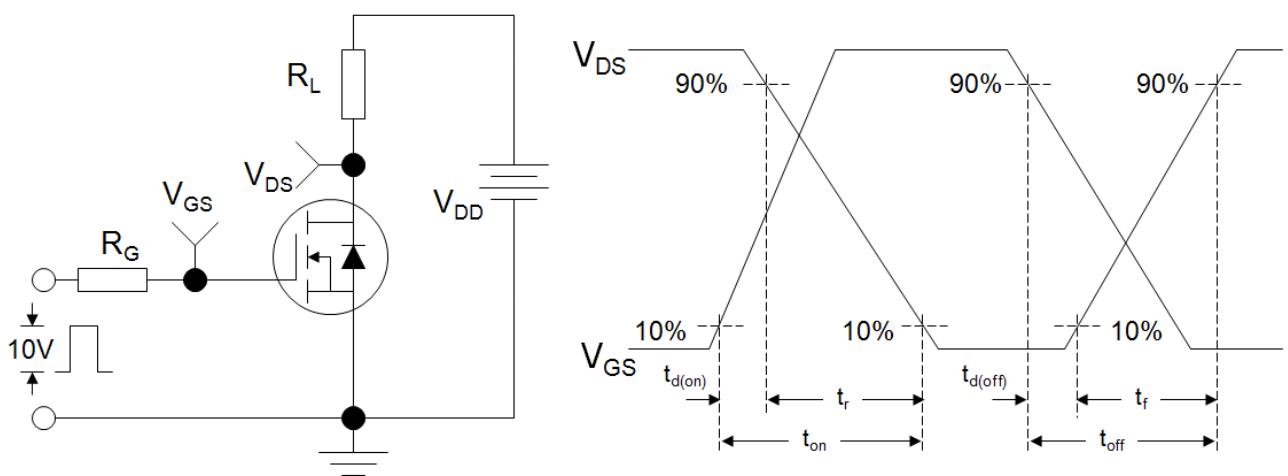
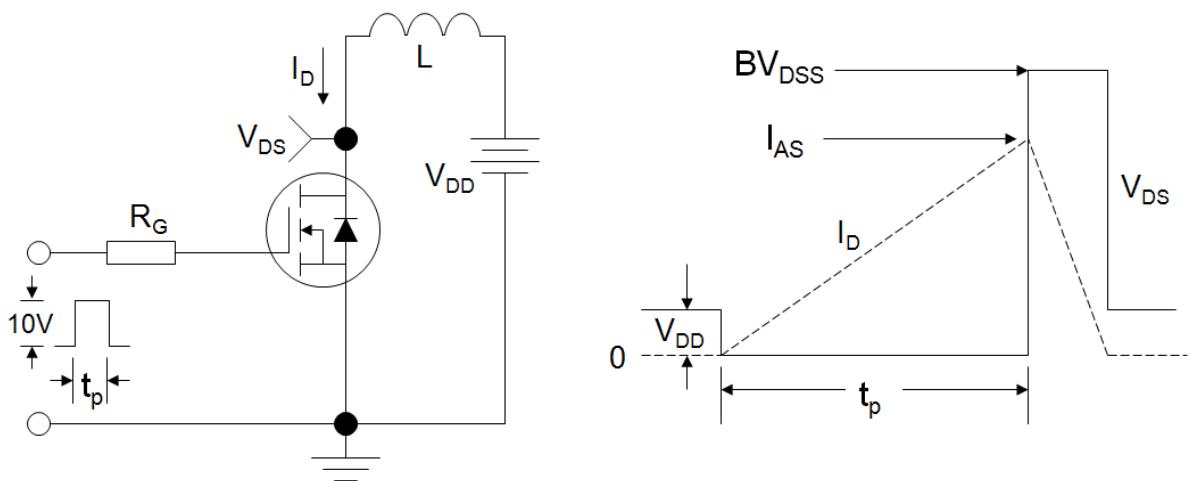


**Figure 9. Transient Thermal Impedance**

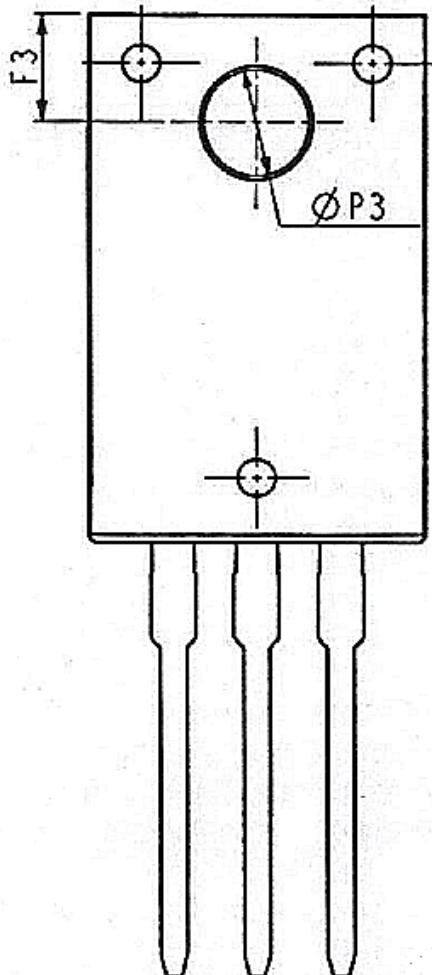
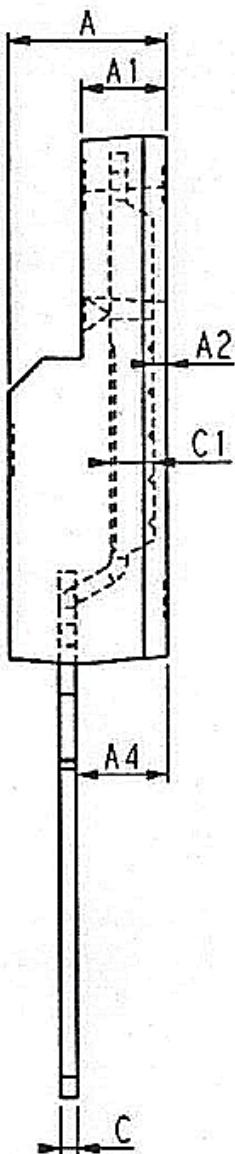
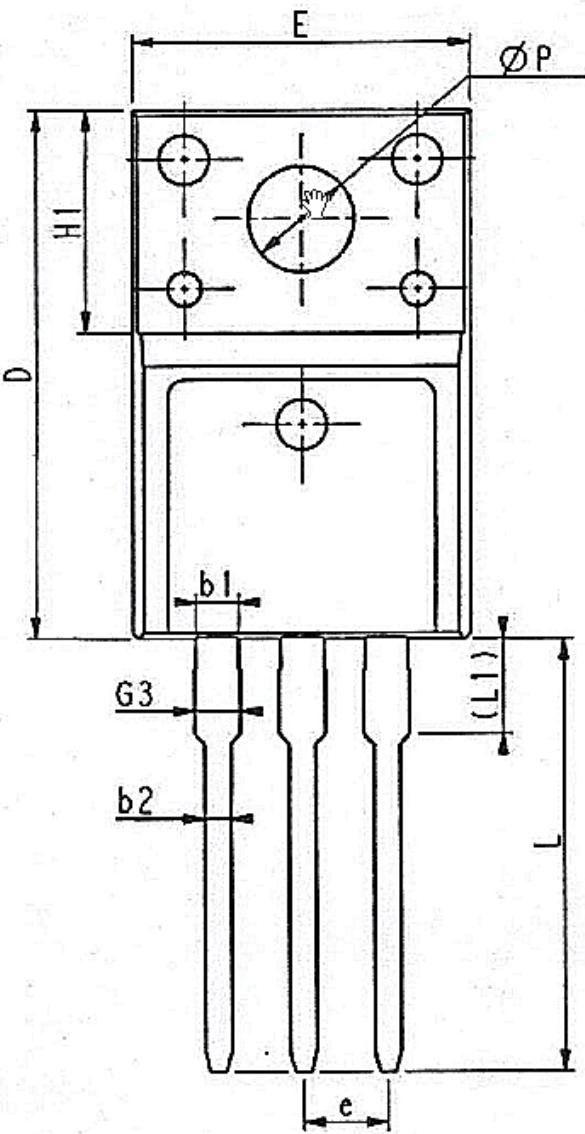


**Figure 10. Safe operation area for**



**Figure A: Gate Charge Test Circuit and Waveform**

**Figure B: Resistive Switching Test Circuit and Waveform**

**Figure C: Unclamped Inductive Switching Test Circuit and Waveform**


## TO-220F



Unit:mm			
Symbol	Min.	Nom	Max.
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.30	0.45	0.60
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
c1	1.20	1.30	1.35
D	15.57	15.87	16.17
H1	6.70REF		

Unit:mm			
Symbol	Min.	Nom	Max.
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
$\odot P$	3.03	3.18	3.38
$\odot P3$	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95



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